

KPHBM-2012SURKCGKC

2.0 x 1.25 mm SMD Chip LED Lamp



DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 2.0 mm x 1.25 mm SMD LED, 0.45 mm max. thickness
- Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Halogen-free
- RoHS compliant

APPLICATIONS

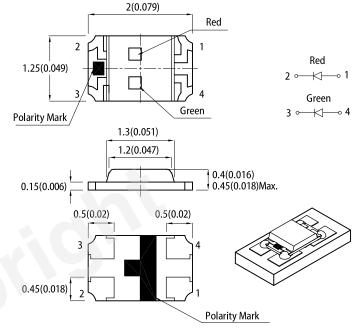
- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

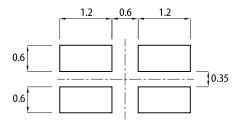


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.1)



- 17. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.1(0.004") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]	
			Min.	Тур.	201/2	
KPHBM-2012SURKCGKC	■ Hyper Red (AlGaInP)	- Water Clear	120	250		
			*40	*80	120°	
	☐ Green (AlGalnP)		20	50	120	
			*20	*50		

61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Тур.	Max.	
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Hyper Red Green	645 574	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Hyper Red Green	630 570	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Hyper Red Green	28 20	-	nm
Capacitance	С	Hyper Red Green	35 15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Hyper Red Green	1.95 2.1	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Hyper Red Green	-	10 10	μА
Temperature Coefficient of λ_{peak} I _F = 20mA, -10° C ≤ T ≤ 85° C	TC_{\lambdapeak}	Hyper Red Green	0.14 0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 20mA, -10°C \leq T \leq 85°C	TC_{\lambdadom}	Hyper Red Green	0.05 0.08	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10° C ≤ T ≤ 85° C	TC _V	Hyper Red Green	-1.9 -1.9	-	mV/°C

Notes:

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

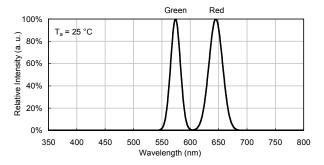
Parameter	Symbol	Value	Unit	
Farameter		Hyper Red	Green	Unit
Power Dissipation	P _D	75	75	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	TJ	115	115	°C
Operating Temperature	T _{op}	-40 To +8	°C	
Storage Temperature	T _{stg}	-40 To +8	°C	
DC Forward Current	l _F	30	30	mA
Peak Forward Current	I _{FM} ^[1]	185	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} [2]	670	610	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	550	490	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. R_{th, th}, R_{th, th} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

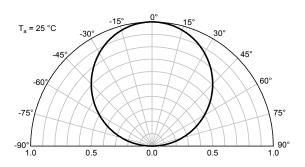


TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

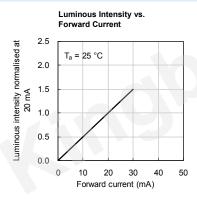


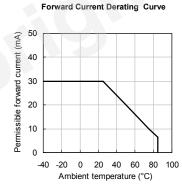
SPATIAL DISTRIBUTION

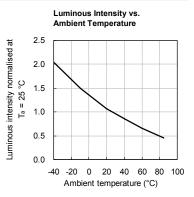


HYPER RED

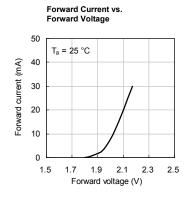
Forward Current vs. Forward Voltage 50 T_a = 25 °C 40 Forward current (mA) 30 20 10 0 1.9 2.1 2.3 Forward voltage (V)

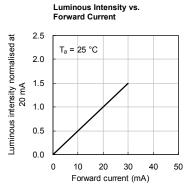


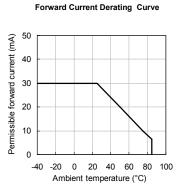


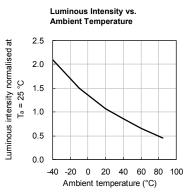


GREEN









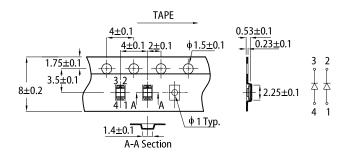


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

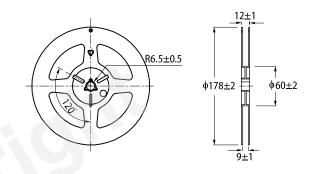
300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max. 200 150 Temperature pre-heating 100 above 217°C 150~200°C 60~120s 60~150s 50 0 50 100 150 200 Time

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product

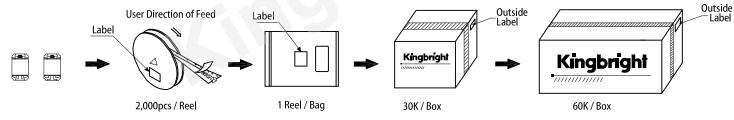
TAPE SPECIFICATIONS (units: mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
- the latest datasheet for the updated specifications.

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